

Package Qualification Report

Reliability By Design

Qualification Description:

The information contained herein represents proof of Reliability and Performance of the Package Series listed below in accordance with the Qualification Plan and test methods referenced in Section 7.0, after exposure to a variety of environments and mechanical events that occur during installation and operational lifetime of the product. Upon conclusion of the testing the product continued to operate within specification limits, demonstrating its capability of reliable operation throughout its lifetime.

The purpose of this report is to present Qualification Test results of the referenced Package Series. The Pericom product data presented in this report qualifies the products manufactured in this package configuration, using the same bill of materials and assembled by the identified subcontractor location. The report describes the qualification test program, procedures utilized, criteria enforced (at the time of product validation), and specific result data obtained during the testing of three lots of semiconductors. The three lots consist of an equal number of units from different date codes, from the same production line and SubContractor to ensure manufacturing repeatability.

Lot Background Information:

| | |
|-------------------|--------------------------------------------|
| Qual Vehicle: | PI3HDMI412ADZBE |
| Supplier (Code): | GTK (G) |
| Pkg Type - Code: | TQFN-56 (ZB56) |
| Outline Drawing: | PD-2008 |
| By Extension Pkg: | ZH42 ZH32 ZH28 ZD48 ZD40 ZF36 ZL64 ZF54 |

All QBE packages pass MSL1, and packing will be as MSL1.

| | |
|-----------------------|--------------------------|
| Qual Test Date: | Dec-2011 update Sep-2016 |
| Die Attach Material: | 1076DJ-G |
| Wire Size & Material: | 0.8 mil PdCu |
| Mold Compound: | G770HJ |
| Leadframe Material: | A194 Copper |
| Lead Finish: | PPF (NiPdAu) |

Date Codes:

Pericom's Qualification Test Results:

| Stress Test | Test Procedure | Test Conditions | Duration | # of Lots | Samples per Lot | Results Pass/Fail |
|----------------------------|--------------------------|--------------------------------------------------------|------------|-----------|-----------------|-------------------|
| Preconditioning | JESD22-A113 | MSL1 (*) see below | NA | 3 | 154 | 462 / 0 |
| CSAM | J-STD-020 | No delamination of Die Top, Wire bond, Down bond areas | NA | 3 | 22 | 66 / 0 |
| PreCon UHAST | JESD22-A118 | 130°C, RH 85%, 33.3 psia, 0V | 96 hrs | 3 | 77 | 231 / 0 |
| PreCon BHAST | JESD22-A110 | 130°C, RH 85%, 33.3 psia, 1.2V | 96 hrs | 3 | 77 | 231 / 0 |
| (QBE from ZL72 - Jun-2014) | | 130°C, RH 85%, 33.3 psia, 1.2V | 192 hrs | 3 | 77 | 231 / 0 |
| PreCon Temp Cycle | JESD22-A104 | -65°C to +150°C 500 Cycles | 100 cycles | 3 | 77 | 231 / 0 |
| | | -65°C to +150°C 500 Cycles | 500 cycles | 3 | 77 | 231 / 0 |
| HTSL (no PreCon) | JESD22-A103 | 1000hrs, 0V, 150°C | 500 hrs | 3 | 77 | 231 / 0 |
| | | 1000hrs, 0V, 150°C | 1000 hrs | 3 | 77 | 231 / 0 |
| Wire Strength, IMG | | After 1000 hours HTSL | NA | 3 | 2 | 6 / 0 |
| Splash, Cratering | | After Wire bonding | NA | 3 | 3 | 9 / 0 |
| Physical Dimension | JESD22-B100 | Per Datasheet | NA | 3 | 5 | 15 / 0 |
| External Visual Insp | JESD22-B101 | NA | NA | 3 | 5 | 15 / 0 |
| Solderability | J-STD-020 JESD22-B102 | Pb-Free Solder Dip 245°C | NA | 3 | 5 | 15 / 0 |

Qualificaton by Extension Information:

Where a product of interest is not sampled during this period, it is valid to use the reliability data of the particular process technology or package type family to which the part belongs. All parts within the same family are designed to the same rules, and manufacturing is controlled by SPC. Within a product family, a device can only be fabricated on one process technology/ option, and only assembled on one package type process.

If there are any questions about this qualification, please contact Quality Support at: customerquestion@pericom.com

(*) Supplier meets requirements of MSL1. Due to one or more suppliers can meet only MSL2, the ZB56 packing shall be MSL2

Date: **Dec-2011 update Sep-2016**

PKG Type & Code: **TQFN-56 (ZB56)** QBE: ZH42 ZH32 ZH28 ZD40 ZD48 ZF36 ZL64

Assembler-Code: **GTK (G)**

Qual Vehicle: **PI3HDMI412ADZBE**

By extension: Pericom active devices using the Package at the time of the Qualification:

| | | | | |
|-------------------|--------------------|------------------|-------------------|-------------------|
| PI2DBS212ZHE | PI3G612ZHE | PI3V712-BZHE | PI6C4911510ZHIE | PI3HDMI301ZLE |
| PI2DBS212ZHEX | PI3G612ZHEX | PI3V712-BZHEX | PI6C4911510ZHIEX | PI3HDMI301ZLEX |
| PI2DBS412ZHE | PI3HDMI101-BZHE | PI3VDP612-AZHE | PI6C49S1510ZDIE | PI3HDMI431ARCZLE |
| PI2DBS412ZHEX | PI3HDMI101-BZHEX | PI3VDP612-AZHE | PI6C49S1510ZDIEX | PI3HDMI431ARCZLEX |
| PI2DBS6212ZHE | PI3HDMI101ZHE | PI3VDP612-AZHE | PI6C49X0210ZHIE | PI3HDMI431ARZLE |
| PI2DBS6212ZHEX | PI3HDMI101ZHE | PI3VDP612-AZHE | PI6C49X0210ZHIEX | PI3HDMI431ARZLEX |
| PI2EQX3421ZHE | PI3HDMI101ZHEX | PI3VDP612-AZHEX | PI6LC4820ZDE | |
| PI2EQX3421ZHE | PI3HDMI101ZHEX | PI3VDP612-AZHEX | PI6LC4820ZDEX | PI3EQX10908AZFE |
| PI2EQX3421ZHEX | PI3HDMI412ADZBE | PI3VDP612-AZHEX | PI6LC4830ZHE | PI3EQX10908AZFEX |
| PI2EQX3421ZHEX | PI3HDMI412ADZBEX | PI3VDP612-AZHEX | PI6LC4830ZHEX | PI3EQX12908AZFE |
| PI2EQX4951SLAZDE | PI3HDMI412FT-AZHE | PI3VDP612ZHE | PI6LC4840ZHE | PI3EQX12908AZFEX |
| PI2EQX4951SLAZDEX | PI3HDMI412FT-AZHEX | PI3VDP612ZHEX | PI6LC4840ZHEX | PI3EQX8908A1ZFE |
| PI2EQX6812ZHE | PI3HDMI412FT-BZHE | PI3VDP8200ZBE | PI6LC4831BZBIE | PI3EQX8908A1ZFEX |
| PI2EQX6812ZHEX | PI3HDMI412FT-BZHEX | PI3VDP8200ZBEX | PI6LC4831BZBIEX | PI3EQX8908AZFE |
| PI2LVD412ZHE | PI3HDMI412FTZHE | PI6LC4831AZBIE | PI2EQX3201BLZFE | PI3EQX8908AZFEX |
| PI2LVD412ZHEX | PI3HDMI412FTZHEX | PI6LC4831AZBIEX | PI2EQX3201BLZFEX | |
| PI2PCIE212ZHE | PI3HDMI412ZHE | PI6LC4833ZBIE | PI2EQX3201BZFE | |
| PI2PCIE212ZHEX | PI3HDMI412ZHEX | PI6LC4833ZBIEX | PI2EQX3201BZFEX | |
| PI2PCIE2212ZHE | PI3L720ZHE | | PI2EQX4401DZFE | |
| PI2PCIE2212ZHEX | PI3L720ZHEX | | PI2EQX4401DZFEX | |
| PI2PCIE2214ZHE | PI3LVD412ZHE | PI2EQX3232AZDE | PI2EQXDP101-AZFE | |
| PI2PCIE2214ZHE | PI3LVD412ZHE | PI2EQX3232AZDEX | PI2EQXDP101-AZFEX | |
| PI2PCIE2214ZHEX | PI3LVD412ZHEX | PI2EQX3232BZDE | PI2EQXDP101ZFE | |
| PI2PCIE2214ZHEX | PI3LVD412ZHEX | PI2EQX3232BZDEX | PI2EQXDP101ZFEX | |
| PI2PCIE2412ZHE | PI3LVD512ZHE | PI2EQX4404ZDE | PI4ULS3V08ZFE | |
| PI2PCIE2412ZHEX | PI3LVD512ZHEX | PI2EQX4404ZDEX | PI4ULS3V08ZFEX | |
| PI2PCIE2422ZHE | PI3PCIE2215ZHE | PI2EQX4432DZDE | PI6LC4872-01ZDE | |
| PI2PCIE2422ZHEX | PI3PCIE2215ZHE | PI2EQX4432DZDEX | PI6LC4872-01ZDEX | |
| PI2PCIE2442ZHE | PI3PCIE2215ZHEX | PI2EQX4832ZDE | PI6LC4872-01ZDIE | |
| PI2PCIE2442ZHEX | PI3PCIE2215ZHEX | PI2EQX4832ZDEX | PI6LC4872-01ZDIEX | |
| PI2PCIE2452ZHE | PI3PCIE2415-AZHE | PI3HDMI415-AZDE | PI6LC4872-02ZDE | |
| PI2PCIE2452ZHEX | PI3PCIE2415-AZHEX | PI3HDMI415-AZDEX | PI6LC4872-02ZDEX | |
| PI2PCIE412-CZHE | PI3PCIE2415ZHE | PI3HDMI415ZDE | PI6LC4872-02ZDIE | |
| PI2PCIE412-CZHEX | PI3PCIE2415ZHEX | PI3HDMI415ZDEX | PI6LC4872-02ZDIEX | |
| PI2PCIE412-DZHE | PI3PCIE3412ZHE | PI3VDP101LSZDE | PI3WVR12612ZHE | |
| PI2PCIE412-DZHEX | PI3PCIE3412ZHEX | PI3VDP101LSZDEX | PI3PD22924CZEE | |
| PI2USB3212ZHE | PI3PCIE3415ZHE | PI3VDP411LSZDE | PI3PD22924CZEE | |
| PI2USB3212ZHEX | PI3PCIE3415ZHEX | PI3VDP411LSZDEX | | |
| PI3EQX4951BZDE | PI3PCIE3422ZHE | PI3VDP611LSZDE | | |
| PI3EQX4951BZDEX | PI3PCIE3422ZHEX | PI3VDP611LSZDEX | | |
| PI3EQX4951STAZDE | PI3PCIE3442ZHE | PI3VDP8122ZDE | | |
| PI3EQX4951STAZDEX | PI3PCIE3442ZHEX | PI3VDP8122ZDEX | | |
| PI3EQX6741STBZDE | PI3PCIE3452ZHE | | | |
| PI3EQX6741STBZDEX | PI3PCIE3452ZHEX | | | |
| PI3EQX7742STZHE | PI3PCIE3462ZHE | | | |
| PI3EQX7742STZHEX | PI3PCIE3462ZHEX | | | |
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